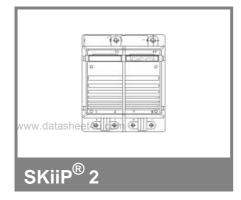
### SKiiP 292GH170-273CTV ...



## 4-pack - integrated intelligent Power System

**Power section** 

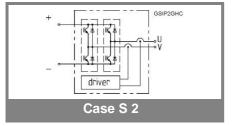
SKiiP 292GH170-273CTV

#### **Features**

- SKiiP technology inside
- Low loss IGBTs
- · CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP<sup>®</sup> 2 System)
- IEC 68T.1 (climate) 40/125/56 (SKiiP<sup>®</sup> 2 power section)
- with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)

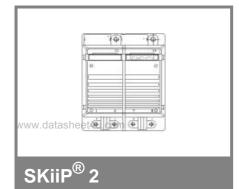
Absolute Maximum Ratings		s = 25 °C unless otherwise specified				
Symbol	Conditions	Values	Units			
IGBT						
$V_{CES}$		1700	V			
V <sub>CES</sub> V <sub>CC</sub> 1)	Operating DC link voltage	1200	V			
$V_{GES}$		± 20	V			
I <sub>C</sub>	T <sub>s</sub> = 25 (70) °C	250 (187,5)	Α			
Inverse diode						
$I_F = -I_C$	T <sub>s</sub> = 25 (70) °C	250 (187,5)	Α			
I <sub>FSM</sub>	$T_i = 150 ^{\circ}\text{C},  t_p = 10 \text{ms};  \text{sin}.$	2160	Α			
I²t (Diode)	Diode, T <sub>j</sub> = 150 °C, 10 ms	23	kA²s			
$T_j$ , $(T_{stg})$		- 40 (- 25) + 150 (125)	°C			
V <sub>isol</sub>	AC, 1 min. (mainterminals to heat sink)	4000	V			

Characteristics T <sub>s</sub> = 25 °C unless otherwise spe							specified		
Symbol   Conditions				min.			Units		
	Condition	OHS			1111111.	typ.	max.	Ullits	
IGBT   $V_{CEsat}$   $I_C$ = 200 A, $T_i$ = 25 (125) °C   3,3 (4,3) 3,9   $V$									
V <sub>CEsat</sub>			25) °C			3,3 (4,3)	3,9 2 (2,3)	V	
V <sub>CEO</sub>	$T_j = 25 (12)$ $T_i = 25 (12)$						2 (2,3) 9,6 (13,2)	=	
r <sub>CE</sub>	,							mΩ	
I <sub>CES</sub>	$V_{GE} = 0 V, V_{CE} = V_{CES},$				(15)	1	mA		
	$T_j = 25 (12)$								
$E_{on} + E_{off}$	I <sub>C</sub> = 200 A, V <sub>CC</sub> = 900 V						173	mJ	
	T <sub>j</sub> = 125 °C	C, V <sub>CC</sub> = 12	200 V				254	mJ	
R <sub>CC' + EE'</sub>	terminal ch	nip, T <sub>i</sub> = 12	5 °C			0,5		mΩ	
L <sub>CE</sub>	top, botton	n ,				15		nΗ	
C <sub>CHC</sub>	per phase	, AC-side				0,8		nF	
Inverse o	diode							•	
$V_F = V_{EC}$	I <sub>F</sub> = 200 A	, T <sub>i</sub> = 25 (1	25) °C			2,3 (2,1)	2,9	V	
V <sub>TO</sub>	$T_i = 25 (12)$					1,3 (1)	1,6 (1,3)	V	
r <sub>T</sub>		T <sub>i</sub> = 25 (125) °C				5 (5,6)	6,3 (7)	mΩ	
E <sub>rr</sub>	$I_{\rm C} = 200  \text{A}$	$V_{CC} = 900$	) V				21	mJ	
	T <sub>j</sub> = 125 °C	C, V <sub>CC</sub> = 12	200 V				25	mJ	
Mechani	cal data								
M <sub>dc</sub>	DC termina	als, SI Unit	S		6		8	Nm	
M <sub>ac</sub>	AC terminals, SI Units				13		15	Nm	
w	SKiiP® 2 System w/o heat sink					1,9		kg	
w	heat sink					4,7		kg	
Thermal	characte	ristics (	P16 hea	t sink; 3	10m <sup>3</sup> /h);	", " refer	ence to	•	
temperat					•	Γ			
R <sub>th(j-s)I</sub>	per IGBT						0,08	K/W	
R <sub>th(j-s)D</sub>	per diode						0,267	K/W	
R <sub>th(s-a)</sub>	per module	е					0,044	K/W	
Z <sub>th</sub>	R <sub>i</sub> (mK/W) (max. values)				tau <sub>i</sub> (s)				
	1	2	3	4	1	2	3	4	
$Z_{th(j-r)I}$	9	62	10		1	0,13	0,001		
$Z_{th(j-r)D}$	29	205	32		1	0,13	0,001		
$Z_{th(r-a)}$	14,2	19,3	6,8	3,7	262	50	5	0,02	



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### SKiiP 292GH170-273CTV ...



# 4-pack - integrated intelligent Power System

4-pack integrated gate driver

SKiiP 292GH170-273CTV

#### **Gate driver features**

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- · Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- · Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 68T.1 (climate) 25/85/56 (SKiiP<sup>®</sup> 2 gate driver)

Absolute Maximum Ratings					
Symbol	Conditions	Values	Units		
$V_{S1}$ $V_{S2}$	stabilized 15 V power supply unstabilized 24 V power supply	18 30	V V		
$V_{iH}$	input signal voltage (high)	15 + 0,3	V		
	secondary to primary side input / output (AC, r.m.s., 2s ) output 1 / output 2 (AC, r.m.s., 2s ) switching frequency operating / storage temperature	75 4000 1500 20 - 25 + 85	kV/µs Vac Vac kHz °C		

Characte	Characteristics			(T <sub>a</sub> = 25		
	Conditions	min.	typ.	max.	Units	
$V_{S1}$	supply voltage stabilized	14,4	15	15,6	V	
$V_{S2}$	supply voltage non stabilized	20	24	30	V	
I <sub>S1</sub>	V <sub>S1</sub> = 15 V	230+36	230+360*f/f <sub>max</sub> +1,3*(I <sub>AC</sub> /A)			
I <sub>S2</sub>	V <sub>S2</sub> = 24 V	170+25	170+250*f/f <sub>max</sub> +1,0*(I <sub>AC</sub> /A)			
$V_{iT+}$	input threshold voltage (High)	11,2			V	
$V_{iT-}$	input threshold voltage (Low)			5,4	V	
R <sub>IN</sub>	input resistance		10		kΩ	
t <sub>d(on)IO</sub>	input-output turn-on propagation time		1,2		μs	
t <sub>d(off)IO</sub>	input-output turn-off propagation time		3		μs	
tpERRRESET	error memory reset time	9			μs	
$t_{TD}$	top / bottom switch : interlock time		2,3		μs	
I <sub>analogOUT</sub>	8 V corresponds to max. current of 15 V supply voltage		250		Α	
I <sub>Vs1outmax</sub>	(available when supplied with 24 V)			50	mA	
I <sub>A0max</sub>	output current at pin 15/16/18/19			5	mA	
V <sub>OI</sub>	logic low output voltage			0,6	V	
V <sub>0H</sub>	logic high output voltage			30	V	
I <sub>TRIPSC</sub>	over current trip level (I <sub>analog OUT</sub> = 10 V)		313		Α	
I <sub>TRIPLG</sub>	ground fault protection		72		Α	
T <sub>tp</sub>	over temperature protection	110		120	°C	
U <sub>DCTRIP</sub>	trip level of U <sub>DC</sub> -protection	1200			V	
	( U <sub>analog OUT</sub> = 9 V); (option)					

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